08-24-2004



DEPARTMENT OF COMMERCE

To the honorable confinissioner of Faterits and Trademarks. Freat	se record the attached original documents or copy thereof.
Name of conveying party(ies):	2. Name and address of receiving party(ies):
John P. Barnak; Gerald B. Feldewerth; Ming Fang; Kevin J. Lee; Tzuen-Luh Huang; Harry Y. Liang; Seshu V. Sattiraju; Margherita Chang; Andrew W.H. Yeoh	Name: Intel Corporation
Additional name(s) of conveying party(ies) attached? ☑ No ☐ Yes	Internal Address: Street Address: 2200 Mission College Bouleve
3. Nature of Conveyance:	
	City: Santa Clara State: CA Zip: 95052
Execution Date: 8-13-2004; 8-14-2004; 8-16-2004	Additional name(s)& address(es) attached? ☑ No ☐
 Application number(s) or patent number(s): If this document is being filed together with a new application 	- T
A. Patent Application No.(s)	B. Patent No.(s)
10/812,464	2
Additional numbers atta	ached? No Yes
concerning document should be mailed: Name: Blakely, Sokoloff, Taylor & Zafman LLP Internal Address:	7. Total Fee (37 CFR 3.41)\$ 40.00 ☑ Enclosed ☐ Authorized to be charged to deposit acco
Street Address: 12400 Wilshire Boulevard	
7th Floor	8. Deposit Account Number:
	02-2666
City: Los Angeles State: CA ZIP: 90025	(Attach duplicate copy of this page if paying by deposit a
DO NOT US	SE THIS SPACE
Statement and signature.	
To the best of my knowledge and belief, the foregoing is true and	1 2M
To the best of my knowledge and belief, the foregoing is true and Gregory D. Caldwell	August 16, 2
To the best of my knowledge and belief, the foregoing is true and	1 2M
To the best of my knowledge and belief, the foregoing is true and Gregory D. Caldwell	August 16, 2 Signature Date

Docket No. 42P19017

PATENT REEL: 015694 FRAME: 0201 Attorney's Docket No.: 42P19017

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned:

John P. Barnak; Gerald B. Feldewerth; Ming Fang; Kevin J. Lee; Tzuen-Luh Huang; Harry Y. Liang; Seshu V. Sattiraju; Margherita Chang; Andrew W.H. Yeoh

hereby sell, assign, and transfer to:

Intel Corporation

a Corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent filed on March 29, 2004, and assigned Application No. 10/812,464 and is entitled:

UNDER BUMP METALLIZATION LAYER TO ENABLE USE OF HIGH TIN CONTENT SOLDER BUMPS

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority from the filing of said United States applications;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, power of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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PATENT REEL: 015694 FRAME: 0202 covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:

8/14/2004	Name: John P. Barnak
Date	Name: John P. Barnak
8/14/2004	21 Tub
Date	Name: Gerald B. Feldewerth
\$/14/2004 Date \$(16/204	Ming Jums
Date	Name: Ming Fang
8/13/04 Date	New J. La
Date	Name: Kevin J. Lee
8/13/04	There
Date	Name: Tauen-Luh Huang
8/13/04	helse
Date	Name: Harry Y. Liang
8/13/04	Name: Seshu V. Sattiraju
Date	Name: Seshu V. Sattiraju
8/16/04	Name: Margherita Chang
Date	Name: Margherita Chang
8/16/04.	AWHYeoli
Date	Name: Andrew W.H. Yeoh
Date	Name:
Date	Name:

Assignment Document Return Address:
BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP
12400 Wilshire Boulevard, 7th Floor
Los Angeles, CA 90025
Telephone: (503) 439-8778

42P19017

RECORDED: 08/20/2004

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